查询"27C64-12/J"供应商

MICROCHIP

27C64

64K (8K x 8) CMOS EPROM

FEATURES

- High speed performance
  - 120 ns access time available
- CMOS Technology for low power consumption
  - 20 mA Active current
  - 100 µA Standby current
- Factory programming available
- Auto-insertion-compatible plastic packages
- Auto ID aids automated programming
- Separate chip enable and output enable controls
- High speed "express" programming algorithm
- Organized 8K x 8: JEDEC standard pinouts
  - 28-pin Dual-in-line package
  - 32-pin Chip carrier (leadless or plastic)
  - 28-pin SOIC package
  - 28-pin TSOP package
  - Tape and reel
- Available for the following temperature ranges:
  - Commercial: 0°C to +70°C
  - Industrial: -40°C to +85°C

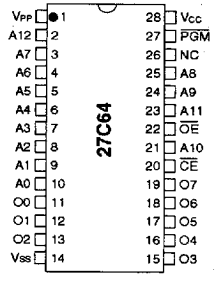
DESCRIPTION

The Microchip Technology Inc. 27C64 is a CMOS 64K bit (electrically) Programmable Read Only Memory. The device is organized as 8K words by 8 bits (8K bytes). Accessing individual bytes from an address transition or from power-up (chip enable pin going low) is accomplished in less than 120 ns. CMOS design and processing enables this part to be used in systems where reduced power consumption and high reliability are requirements.

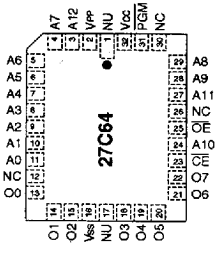
A complete family of packages is offered to provide the most flexibility in applications. For surface mount applications, PLCC, SOIC, or TSOP packaging is available. Tape and reel packaging is also available for PLCC or SOIC packages. UV erasable versions are also available.

PACKAGE TYPE

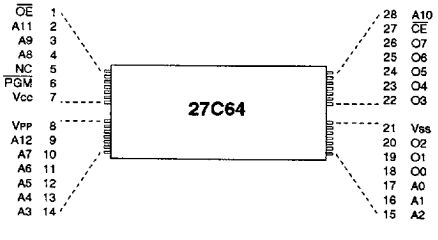
DIP/SOIC



PLCC/LCC



TSOP



7

© 1995 Microchip Technology Inc.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

1.0 ELECTRICAL CHARACTERISTICS

查询"27C64-12/L"供应商

1.1 Maximum Ratings*

V_{CC} and input voltages w.r.t. V_{SS} ..... -0.6V to + 7.25V

V_{PP} voltage w.r.t. V_{SS} during programming ..... -0.6V to +14V

Voltage on A9 w.r.t. V_{SS} ..... -0.6V to +13.5V

Output voltage w.r.t. V_{SS} ..... -0.6V to V_{CC} +1.0V

Storage temperature ..... -65°C to +150°C

Ambient temp. with power applied ..... -65°C to +125°C

*Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 1-1: PIN FUNCTION TABLE

Name	Function
A0-A12	Address Inputs
$\overline{CE}$	Chip Enable
$\overline{OE}$	Output Enable
$\overline{PGM}$	Program Enable
V_{PP}	Programming Voltage
O0 - O7	Data Output
V_{CC}	+5V Power Supply
V_{SS}	Ground
NC	No Connection; No Internal Connections
NU	Not Used; No External Connection Is Allowed

TABLE 1-2: READ OPERATION DC CHARACTERISTICS

V_{CC} = +5V (±10%)
Commercial: Tamb = 0°C to +70°C
Industrial: Tamb = -40°C to +85°C

Parameter	Part*	Status	Symbol	Min	Max	Units	Conditions
Input Voltages	all	Logic "1" Logic "0"	V_{IH} V_{IL}	2.0 -0.5	V_{CC}+1 0.8	V V	
Input Leakage	all	—	I_{LI}	-10	10	µA	V_{IN} = 0 to V_{CC}
Output Voltages	all	Logic "1" Logic "0"	V_{OH} V_{OL}	2.4	 0.45	V V	I_{OH} = -400 µA I_{OL} = 2.1 mA
Output Leakage	all	—	I_{LO}	-10	10	µA	V_{OUT} = 0V to V_{CC}
Input Capacitance	all	—	C_{IN}	—	6	pF	V_{IN} = 0V; Tamb = 25°C; f = 1 MHz
Output Capacitance	all	—	C_{OUT}	—	12	pF	V_{OUT} = 0V; Tamb = 25°C; f = 1 MHz
Power Supply Current, Active	C I	TTL input TTL input	I_{CC1} I_{CC2}	— —	20 25	mA mA	V_{CC} = 5.5V; V_{PP} = V_{CC}; f = 1 MHz; $\overline{OE}$ = $\overline{CE}$ = V_{IL}; I_{OUT} = 0 mA; V_{IL} = -0.1 to 0.8V; V_{IH} = 2.0 to V_{CC}; Note 1
Power Supply Current, Standby	C I all	TTL input TTL input CMOS input	$I_{CC(S)}$ — —	— — —	2 3 100	mA mA µA	 $\overline{CE}$ = V_{CC} ± 0.2V
I_{PP} Read Current V_{PP} Read Voltage	all all	Read Mode Read Mode	I_{PP} V_{PP}	 V_{CC}-0.7	100 V_{CC}	µA V	V_{PP} = 5.5V Note 2

* Parts: C=Commercial Temperature Range; I =Industrial Temperature Range

Note 1: Typical active current increases .5 mA per MHz up to operating frequency for all temperature ranges.

Note 2: V_{CC} must be applied before V_{PP}, and be removed simultaneously or after V_{PP}.

6103201 0012423 86T

© 1995 Microchip Technology Inc.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

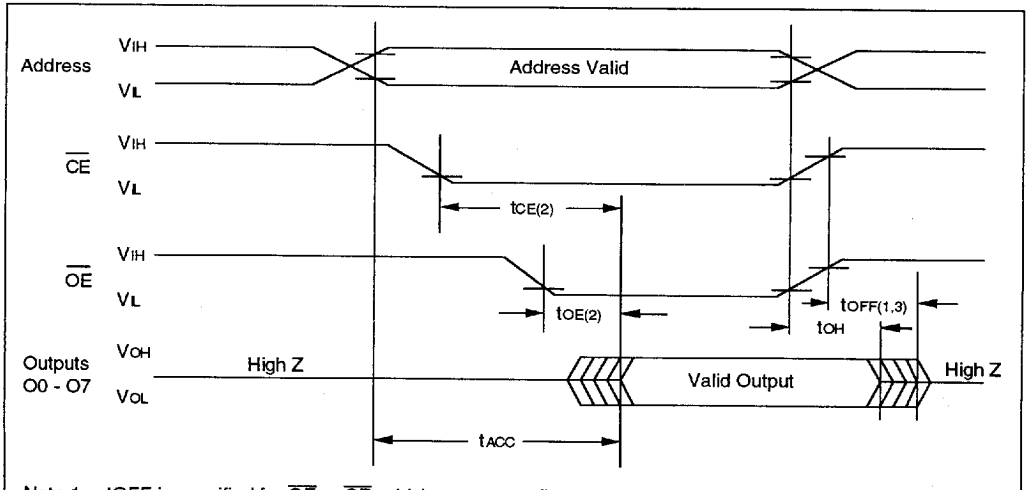
TABLE 1-3: READ OPERATION AC CHARACTERISTICS

查询"27C64-12/J"供应商

AC Testing Waveform:	V_{IH} = 2.4V and V_{IL} = 0.45V; V_{OH} = 2.0V V_{OL} = 0.8V	
Output Load:	1 TTL Load + 100 pF	
Input Rise and Fall Times:	10 ns	
Ambient Temperature:	Commercial:	Tamb = 0°C to +70°C
	Industrial:	Tamb = -40°C to +85°C

Parameter	Sym	27C64-12		27C64-15		27C64-17		27C64-20		27C64-25		Units	Conditions
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
Address to Output Delay	t_{ACC}	—	120	—	150	—	170	—	200	—	250	ns	$\overline{CE}$ = $\overline{OE}$ = V_{IL}
$\overline{CE}$ to Output Delay	t_{CE}	—	120	—	150	—	170	—	200	—	250	ns	$\overline{OE}$ = V_{IL}
$\overline{OE}$ to Output Delay	t_{OE}	—	65	—	70	—	70	—	75	—	100	ns	$\overline{CE}$ = V_{IL}
$\overline{CE}$ or $\overline{OE}$ to O/P High Impedance	t_{OFF}	0	50	0	50	0	50	0	55	0	60	ns	
Output Hold from Address $\overline{CE}$ or $\overline{OE}$, whichever occurs first	t_{OH}	0	—	0	—	0	—	0	—	0	—	ns	

FIGURE 1-1: READ WAVEFORMS



Note 1: tOFF is specified for $\overline{OE}$ or $\overline{CE}$, whichever occurs first.
Note 2: $\overline{OE}$ may be delayed up to tCE - tOE after the falling edge of $\overline{CE}$ without impact on tCE.
Note 3: This parameter is sampled and is not 100% tested.

7

Powered by ICminer.com Electronic-Library Service CopyRight 2003

TABLE 1-4: PROGRAMMING DC CHARACTERISTICS

查询"27C64-12/J"供应商

Ambient Temperature: Tamb = 25°C ± 5°C
V_{CC} = 6.5V ± 0.25V, V_{PP} = V_H = 13.0V ± 0.25V

Parameter	Status	Symbol	Min	Max.	Units	Conditions
Input Voltages	Logic"1" Logic"0"	V_{IH} V_{IL}	2.0 -0.1	V_{CC}+1 0.8	V V	
Input Leakage	—	I_{LI}	-10	10	µA	V_{IN} = 0V to V_{CC}
Output Voltages	Logic"1" Logic"0"	V_{OH} V_{OL}	2.4 —	— 0.45	V V	I_{OH} = -400 µA I_{OL} = 2.1 mA
V_{CC} Current, program & verify	—	I_{CC2}	—	20	mA	Note 1
V_{PP} Current, program	—	I_{PP2}	—	25	mA	Note 1
A9 Product Identification	—	V_H	11.5	12.5	V	

Note 1: V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}.

TABLE 1-5: PROGRAMMING AC CHARACTERISTICS

for Program, Program Verify and Program Inhibit Modes

AC Testing Waveform: V_{IH}=2.4V and V_{IL}=0.45V; V_{OH}=2.0V; V_{OL}=0.8V
Ambient Temperature: Tamb=25°C ±5°C
V_{CC}= 6.5V ± 0.25V, V_{PP} = V_H = 13.0V ± 0.25V

Parameter	Symbol	Min	Max	Units	Remarks
Address Set-Up Time	t_{AS}	2	—	µs	
Data Set-Up Time	t_{DS}	2	—	µs	
Data Hold Time	t_{DH}	2	—	µs	
Address Hold Time	t_{AH}	0	—	µs	
Float Delay (2)	t_{DF}	0	130	ns	
V_{CC} Set-Up Time	t_{VCS}	2	—	µs	
Program Pulse Width (1)	t_{PW}	95	105	µs	100 µs typical
$\overline{CE}$ Set-Up Time	t_{CES}	2	—	µs	
$\overline{OE}$ Set-Up Time	t_{OES}	2	—	µs	
V_{PP} Set-Up Time	t_{VPS}	2	—	µs	
Data Valid from $\overline{OE}$	t_{OE}	—	100	ns	

Note 1: For express algorithm, initial programming width tolerance is 100 µs ±5%.
Note 2: This parameter is only sampled and not 100% tested. Output float is defined as the point where data is no longer driven (see timing diagram).

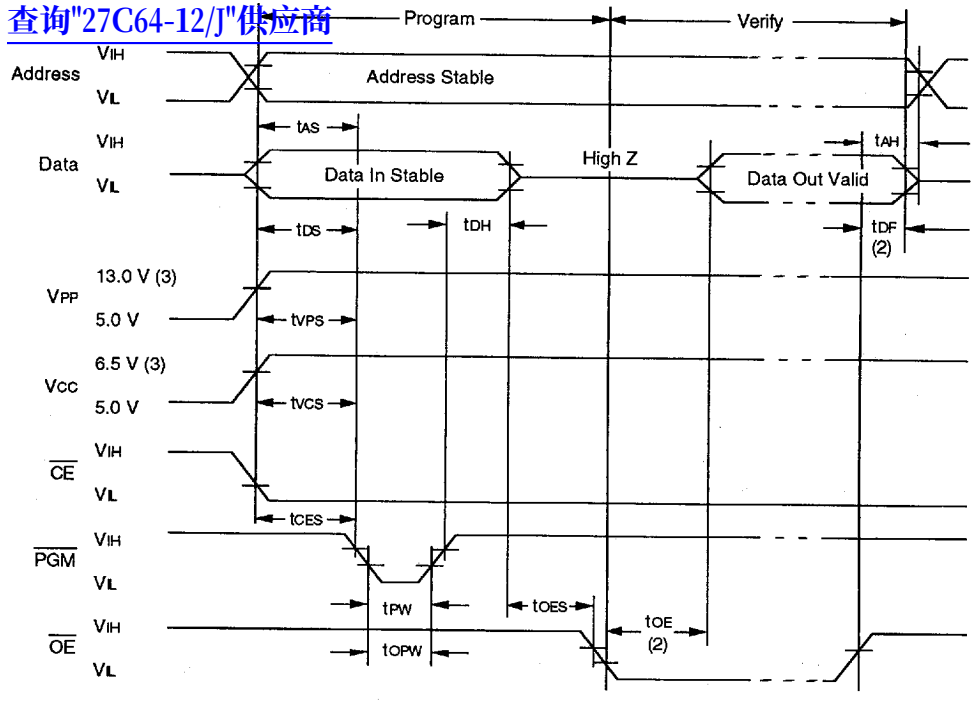
6103201 0012425 632

© 1995 Microchip Technology Inc.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

FIGURE 1-2: PROGRAMMING WAVEFORMS (1)

查询"27C64-12/J"供应商



Notes: (1) The input timing reference is 0.8 V for V_{IL} and 2.0 V for V_{IH}.
(2) t_{DF} and t_{OE} are characteristics of the device but must be accommodated by the programmer.
(3) V_{CC} = 6.5 V ±0.25 V, V_{PP} = V_H = 13.0 V ±0.25 V for Express algorithm.

TABLE 1-6: MODES

Operation Mode	$\overline{CE}$	$\overline{OE}$	$\overline{PGM}$	V_{PP}	A9	O0 - O7
Read	V_{IL}	V_{IL}	V_{IH}	V_{CC}	X	D_{OUT}
Program	V_{IL}	V_{IH}	V_{IL}	V_H	X	D_{IN}
Program Verify	V_{IL}	V_{IL}	V_{IH}	V_H	X	D_{OUT}
Program Inhibit	V_{IH}	X	X	V_H	X	High Z
Standby	V_{IH}	X	X	V_{CC}	X	High Z
Output Disable	V_{IL}	V_{IH}	V_{IH}	V_{CC}	X	High Z
Identity	V_{IL}	V_{IL}	V_{IH}	V_{CC}	V_H	Identity Code

X = Don't Care

1.2 Read Mode

(See Timing Diagrams and AC Characteristics)

Read Mode is accessed when

a) the $\overline{CE}$ pin is low to power up (enable) the chip
b) the $\overline{OE}$ pin is low to gate the data to the output pins

For Read operations, if the addresses are stable, the address access time (t_{ACC}) is equal to the delay from $\overline{CE}$ to output (t_{CE}). Data is transferred to the output after a delay from the falling edge of $\overline{OE}$ (t_{OE}).

© 1995 Microchip Technology Inc.

6103201 0012426 579

Powered by ICminer.com Electronic-Library Service CopyRight 2003

1.3 Standby Mode

查询"27C64-12/I"供应商

The standby mode is defined when the $\overline{CE}$ pin is high (VIH) and a program mode is not defined.

When these conditions are met, the supply current will drop from 20 mA to 100 µA.

1.4 Output Enable

This feature eliminates bus contention in microprocessor-based systems in which multiple devices may drive the bus. The outputs go into a high impedance state when the following condition is true:

- The $\overline{OE}$ and $\overline{PGM}$ pins are both high.

1.5 Erase Mode (U.V. Windowed Versions)

Windowed products offer the capability to erase the memory array. The memory matrix is erased to the all 1's state when exposed to ultraviolet light. To ensure complete erasure, a dose of 15 watt-second/cm^2 is required. This means that the device window must be placed within one inch and directly underneath an ultraviolet lamp with a wavelength of 2537 Angstroms, intensity of 12,000µW/cm^2 for approximately 20 minutes.

1.6 Programming Mode

The Express Algorithm has been developed to improve the programming throughput times in a production environment. Up to ten 100-microsecond pulses are applied until the byte is verified. No overprogramming is required. A flowchart of the express algorithm is shown in Figure 1-3.

Programming takes place when:

a) Vcc is brought to the proper voltage,
b) VPP is brought to the proper VH level,
c) the $\overline{CE}$ pin is low,
d) the $\overline{OE}$ pin is high, and
e) the $\overline{PGM}$ pin is low.

Since the erased state is "1" in the array, programming of "0" is required. The address to be programmed is set via pins A0-A12 and the data to be programmed is presented to pins O0-O7. When data and address are stable, $\overline{OE}$ is high, $\overline{CE}$ is low and a low-going pulse on the $\overline{PGM}$ line programs that location.

1.7 Verify

After the array has been programmed it must be verified to ensure all the bits have been correctly programmed. This mode is entered when all the following conditions are met:

a) Vcc is at the proper level,
b) VPP is at the proper VH level,
c) the $\overline{CE}$ line is low,
d) the $\overline{PGM}$ line is high, and
e) the $\overline{OE}$ line is low.

1.8 Inhibit

When programming multiple devices in parallel with different data, only $\overline{CE}$ or $\overline{PGM}$ need be under separate control to each device. By pulsing the $\overline{CE}$ or $\overline{PGM}$ line low on a particular device in conjunction with the $\overline{PGM}$ or $\overline{CE}$ line low, that device will be programmed; all other devices with $\overline{CE}$ or $\overline{PGM}$ held high will not be programmed with the data, although address and data will be available on their input pins (i.e., when a high level is present on $\overline{CE}$ or $\overline{PGM}$); and the device is inhibited from programming.

1.9 Identity Mode

In this mode, specific data is output which identifies the manufacturer as Microchip Technology Inc. and device type. This mode is entered when Pin A9 is taken to VH (11.5V to 12.5V). The $\overline{CE}$ and $\overline{OE}$ lines must be at VIL. A0 is used to access any of the two non-erasable bytes whose data appears on O0 through O7.

Pin →	Input	Output								
Identity ↓	A0	O7	O6	O5	O4	O3	O2	O1	O0	Hex
Manufacturer	VIL	0	0	1	0	1	0	0	1	29
Device Type*	VIH	0	0	0	0	0	0	1	0	02

* Code subject to change

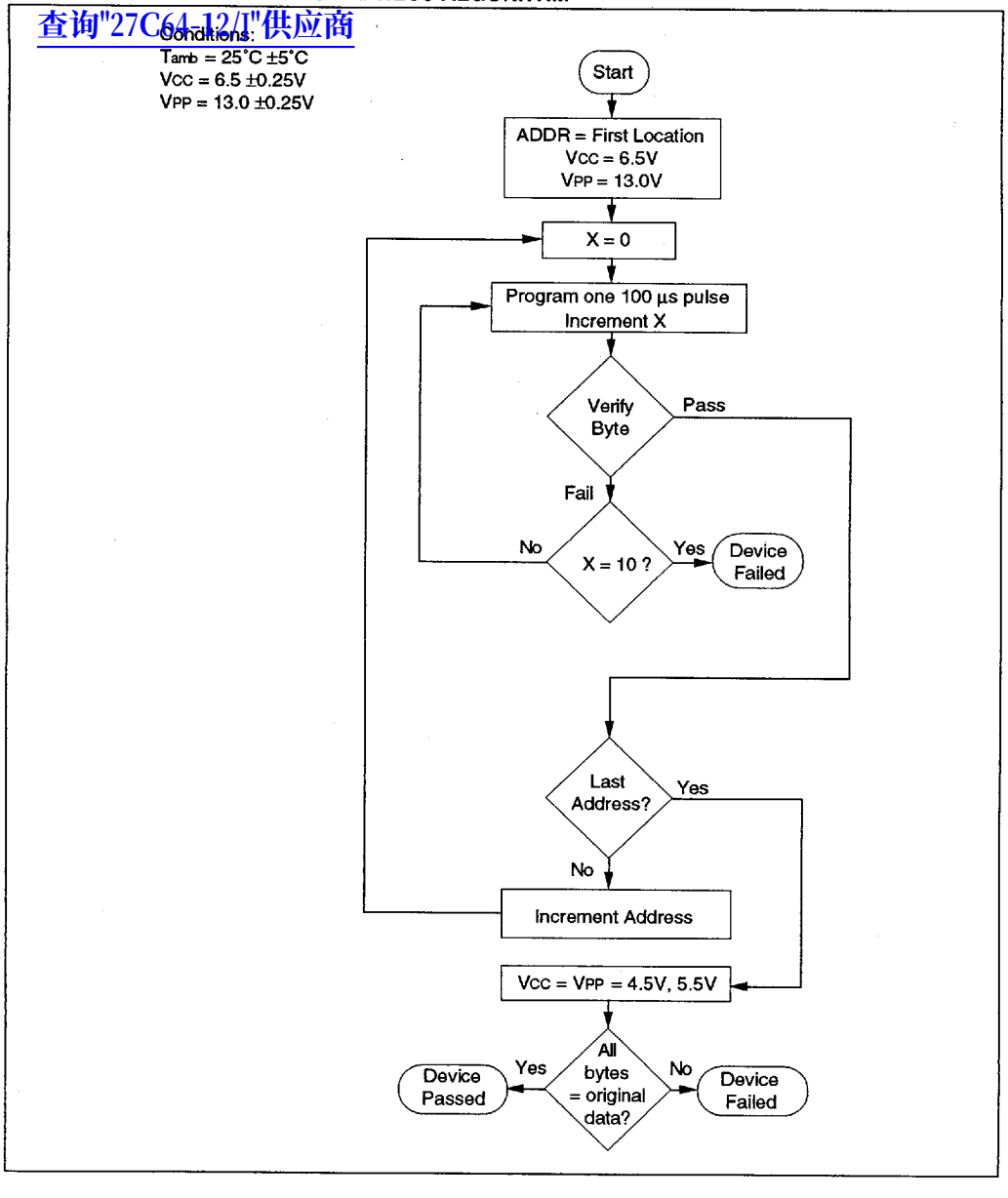
6103201 0012427 405

© 1995 Microchip Technology Inc.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

FIGURE 1-3: PROGRAMMING EXPRESS ALGORITHM

查询"27C64-12/J"供应商



© 1995 Microchip Technology Inc.

6103201 0012428 341

Powered by ICminer.com Electronic-Library Service CopyRight 2003

27C64 Product Identification System

To order or to obtain information, e.g. on pricing or delivery, please use the listed part numbers, and refer to the factory or the listed sales offices.

查询"27C64-12/J"供应商

27C64 - 25 I /K

Package:	J	CERDIP
	K	Ceramic Leadless Chip Carrier
	L	Plastic Leaded Chip Carrier
	P	Plastic DIP
	SO	Plastic SOIC
	TS	Thin Small Outline Package (TSOP) 8X13.4mm
Temperature Range:	-	0°C to +70°C
	I	–40°C to +85°C
Access Time:	12	120 ns
	15	150 ns
	17	170 ns
	20	200 ns
	25	250 ns
Device:	27C64	64K (8K x 8) CMOS EPROM

6103201 0012429 288

© 1995 Microchip Technology Inc.

Powered by ICminer.com Electronic-Library Service CopyRight 2003